09-09-2004

FORM PTO-1595 4 3 1 0 4 1028321	T U.S. DEPARTMENT OF COMME Patent and Trademark 0
To the Honorable Commissioner of Patents and Trademarks: F	Please record theached original documents or copy thereof.
Name of conveying party(ies)	Name and address of receiving party(ies):
Zachary A. Prather, Steven E. Reder and Michael J. Berman	Name: LSI LOGIC CORORATION (1.0)
Additional name(s) of conveying party(ies) attached? 🖵 Yes 🏻 No	Internal Address: 1621 BARBER LANE
	MILPITAS, CALIFORNIA 95035
Nature of conveyance:	Street Address: SAME AS ABOVE
☐ Merger	
☐ Securing Agreement ☐ Change of Name ☐ Other	City:State:Zip:
xecution Date: Zachary A. Prather - August 3, 2004; Steven E. Reder - July 27, 2004; and Michael J. Berman - August 14, 2004.	— Additional name(s) and address(es) attached? □ Yes ⊠ No —— —— ——
Additional numbers also	· bichad2 □ Vec ≅ Na
3	ached? ☐ Yes ⊠ No 6. Total number of applications and patents involved:
Name and address of party to whom correspondence concerning document should be mailed:	
. Name and address of party to whom correspondence concerning document should be mailed: Name: Timothy R. Croll, Reg. No. 36,711	
Name and address of party to whom correspondence concerning document should be mailed: Name: Timothy R. Croll, Reg. No. 36,711 Internal Address: LSI LOGIC CORPORATION LEGAL DEPARTMENT-IP 1621 BARBER LANE, MS D-106	
Name and address of party to whom correspondence concerning document should be mailed: Name: Timothy R. Croll, Reg. No. 36,711 Internal Address: LSI LOGIC CORPORATION LEGAL DEPARTMENT-IP	6. Total number of applications and patents involved:
Name and address of party to whom correspondence concerning document should be mailed: Name: Timothy R. Croll, Reg. No. 36,711 Internal Address: LSI LOGIC CORPORATION	6. Total number of applications and patents involved: 1 7. Total fee (37 CFR 3.41)
Name and address of party to whom correspondence concerning document should be mailed: Name: Timothy R. Croll, Reg. No. 36,711 Internal Address: LSI LOGIC CORPORATION	6. Total number of applications and patents involved: 1 7. Total fee (37 CFR 3.41)
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TREXLER, BUSHNELL, GIANGIORGY, BLACKSTONE & MARR, LTD. • 105 W. ADAMS ST. • CHICAGO, ILLINOIS 60603 • (312) 704-1890

PATENT REEL: 015759 FRAME: 0324

ASSIGNMENT OF APPLICATION

Docket Number:

04-0746

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged,

We, the undersigned,

do hereby sell, assign, and transfer to:

LSI LOGIC CORPORATION, a corporation of Delaware, having a place of business at 1621 Barber Lane, Milpitas, California 95035, ("Assignee"), its successors, assigns, and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all inventions and improvements which are disclosed in the application for United States Letters Patent,

which has been executed by the undersigned concurrently herewith,

and which is entitled:

METHOD FOR HEAT DISSIPATION ON SEMICONDUCTOR DEVICE

in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application; and

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications to patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Invent Name-	Zoch Pat	Date: 8/3/04	
Nama	Zuchary France	·	
rame.	Steven E. Reder	Date:	
Name _.	Michael J. Berman	Date:	
Witnes	ss Signature:		
Witnes	ss Printed Name:		
Witnes	ss Address:		

669817.WPD

ASSIGNMENT OF APPLICATION

Docket Number:

04-0746

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LSI LOGIC CORPORATION, a corporation of Delaware, having a place of business at 1621 Barber Lane, Milpitas, California 95035, ("Assignee"), its successors, assigns, and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all inventions and improvements which are disclosed in the application for United States Letters Patent,

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METHOD FOR HEAT DISSIPATION ON SEMICONDUCTOR DEVICE

in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application; and

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications to patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

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Name Zachary Prather Name Steven E. Reder Date: 7-27-04

Michael J. Berman

Witness Signature:

Witness Address: 23400 NE GUSAN ST GREETHAM OR 97

669817 WPD

Witness Printed Name:

Name

Inventors:

ASSIGNMENT OF APPLICATION

Docket Number:

04-0746

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METHOD FOR HEAT DISSIPATION ON SEMICONDUCTOR DEVICE

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inventors:	
NameZachary Prather	Date:
Zachary Prather	
Name Steven E. Reder	Date:
Sieven z. Reder	
Name ////////////////////////////////////	Date: 1/6 14,2004
Witness Signature:	
Witness Printed Name:	
Witness Address:	
669817.W(PI)	

PATENT REEL: 015759 FRAME: 0327